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FORM PTO-1595

(Rev. 6-93)

OMB No. 0651-0011 (exp. 4/94)



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COVER SHEET U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

Atty Dkt No. 99 P 7602 US

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof

1. Name of conveying party(ies):

Brian S. LEE

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: Infineon Technologies Corporation

Internal Address:

Street Address: 10950 North Tantau Avenue

City: Cupertino State: CA ZIP: 95014

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

Execution Date: May 14, 1999

4. Application number(s) or patent number(s):

09/314,358

If this document is being filed together with a new application, the execution date of the application is: May 14, 1999

A. Patent Application No.(s)

B. Patent No.(s)

To be assigned

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Elsa Keller

Internal Address:

Siemens Corporation

Intellectual Property Department

Street Address: 186 Wood Avenue South

City: Iselin State: NJ ZIP: 08830

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41) \$ 40.00

☐ Enclosed

☒ Authorized to be charged to deposit account

8. Deposit Account No.

19-2179

DO NOT USE THIS SPACE

05/27/1999 MTHAI1 00000161 192179 09314358

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9. Statement and signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Donald B. Paschburg

Name of Person Signing

Reg. No. 32,556

Donald B. Paschburg
Signature

May 19, 1999

Date

Total number of pages including cover sheet, attachments, and document: 3

ASSIGNMENT

For good and valuable consideration, I, Brian S. Lee, residing at 425 E. 76th Street #10D, New York, New York 10021, a citizen of Korea,

Hereby sell, assign, and transfer to Infineon Technologies Corporation, a corporation organized and existing under the laws of the state of Delaware, having its principal place of business at 10950 North Tantau Ave., Cupertino, CA 95014,

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewithin, and is entitled:

DIFFERENTIAL TRENCH OPEN PROCESS

and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

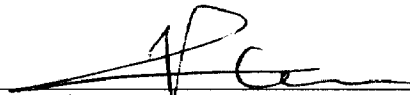
Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

PATENT

" REEL: 009976 FRAME: 0911

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 5/14/99


Brian S. Lee

Witness: Alexander Michalis
(type name)

Witness: Mois Gubman
(type name)